

SNS COLLEGE OF TECHNOLOGY

(An Autonomous Institution)

COIMBATORE-35

Accredited by NBA-AICTE and Accredited by NAAC – UGC with A+ Grade **Approved by AICTE, New Delhi & Affiliated to Anna University, Chennai**

DEPARTMENT OF BIOMEDICAL ENGINEERING

COURSE NAME: 19EIB201/ ELECTRONIC DEVICES

II YEAR / III SEMESTER

Unit 1 – Transistors

Topic 2: MOSFET







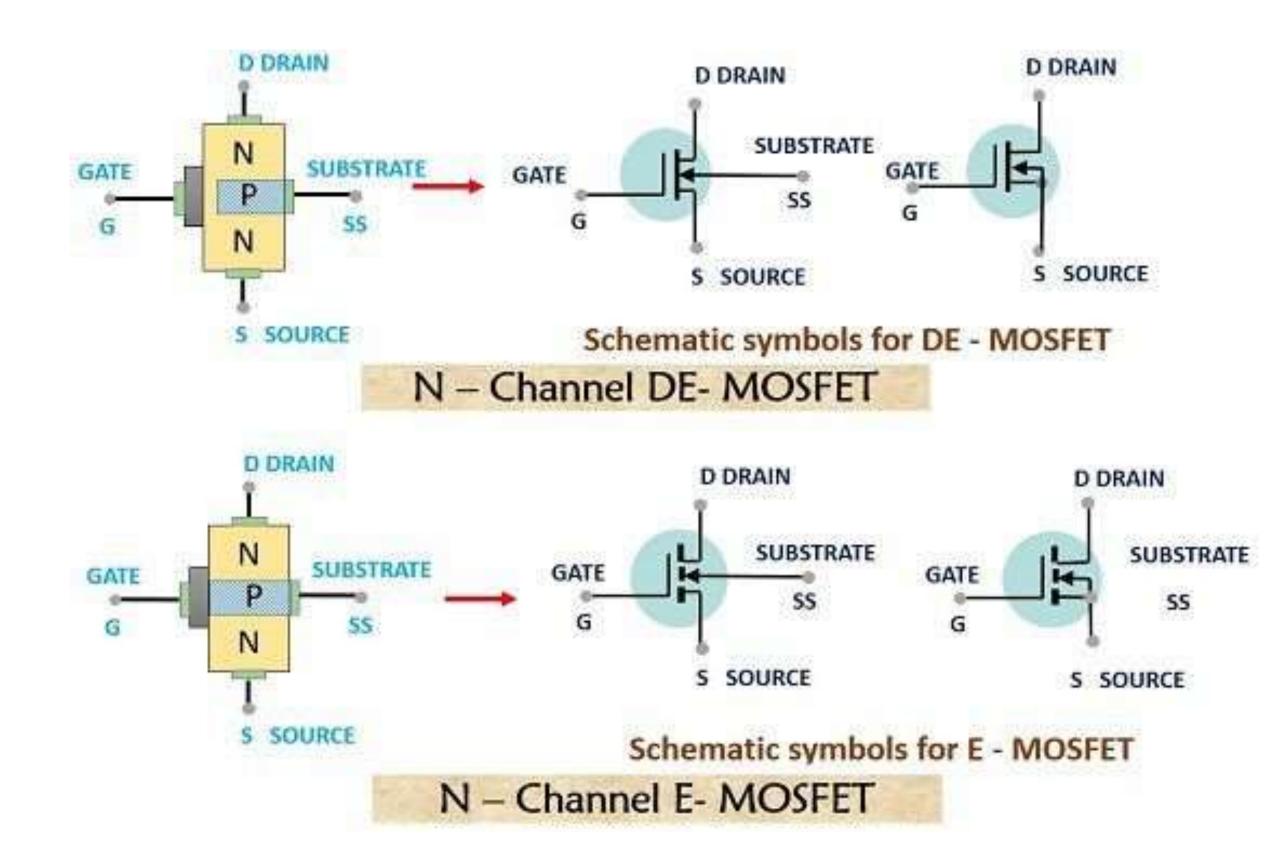


MOSFET

- MOSFET is an acronym for Metal Oxide Semi-Conductor Field Effect Transistor. It is a device in which the variation in the voltage determines the conductivity of the device. It is a three terminal device which has a source, a drain and a gate terminal.
- These are voltage controlled devices, in which the current flowing between source and drain is proportional to the provided input voltage.
- MOSFET has a smaller value of capacitance and its input impedance is much more than that of FET due to small leakage current.
- It finds application widely in switching and amplification of electronic signals because of its ability to change conductivity with the applied voltage.



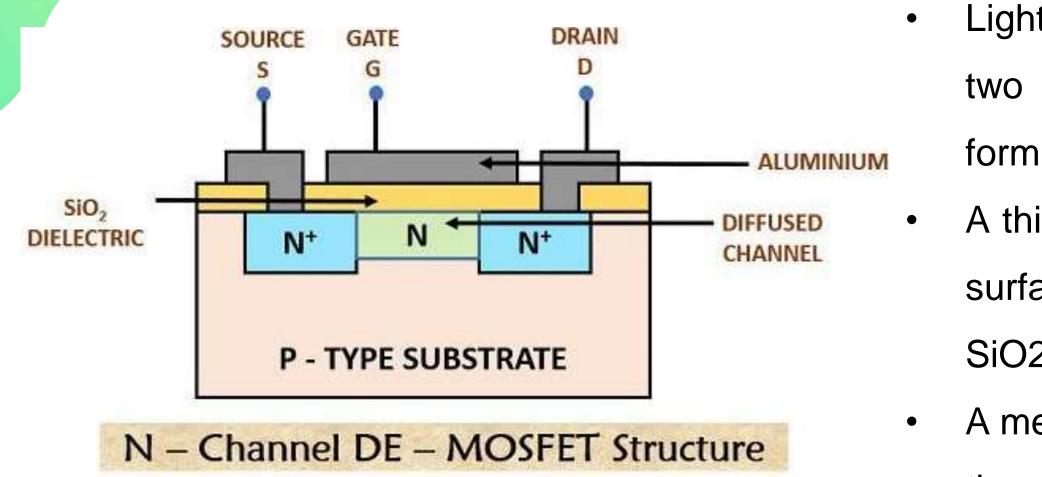
MOSFET



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Construction of a depletion type MOSFET 妄



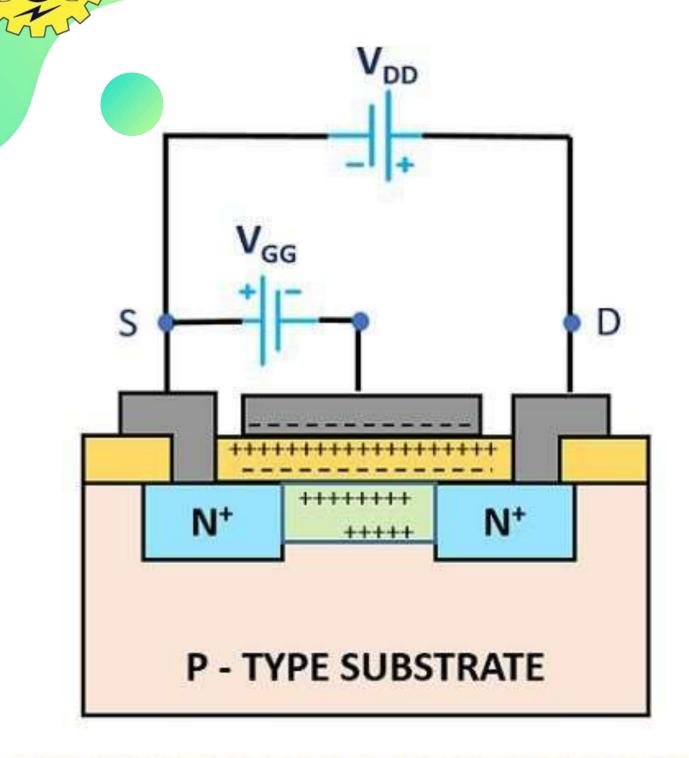
- Lightly doped P-type substrate contains two heavily doped N-type material thus forming source and drain.
- SiO2.
- A metal plate is also deposited in between the source and drain terminal which acts as gate terminal for the device.
- The layer of SiO₂ provides an extremely high input impedance of the order of **10**¹⁰ to **10**¹⁵ ohms.

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- A thin layer of SiO2 is deposited over the
- surface and holes are then cut through

Working of a Depletion-type MOSFET 🕿



Depletion Mode Operation

- In a DE-MOSFET when the gate potential is made negative with respect to the substrate, it causes repulsion of negative charge carriers out of the initially formed channel.
- This increases the channel resistance which \bullet resultantly reduces the drain current.
- In the case when the gate terminal is made \bullet positive with respect to the substrate, more number of electrons gets attracted towards the channel. Thus, causing more current to flow through the channel.
- A pinch-off condition also arises in DE-MOS when ullet

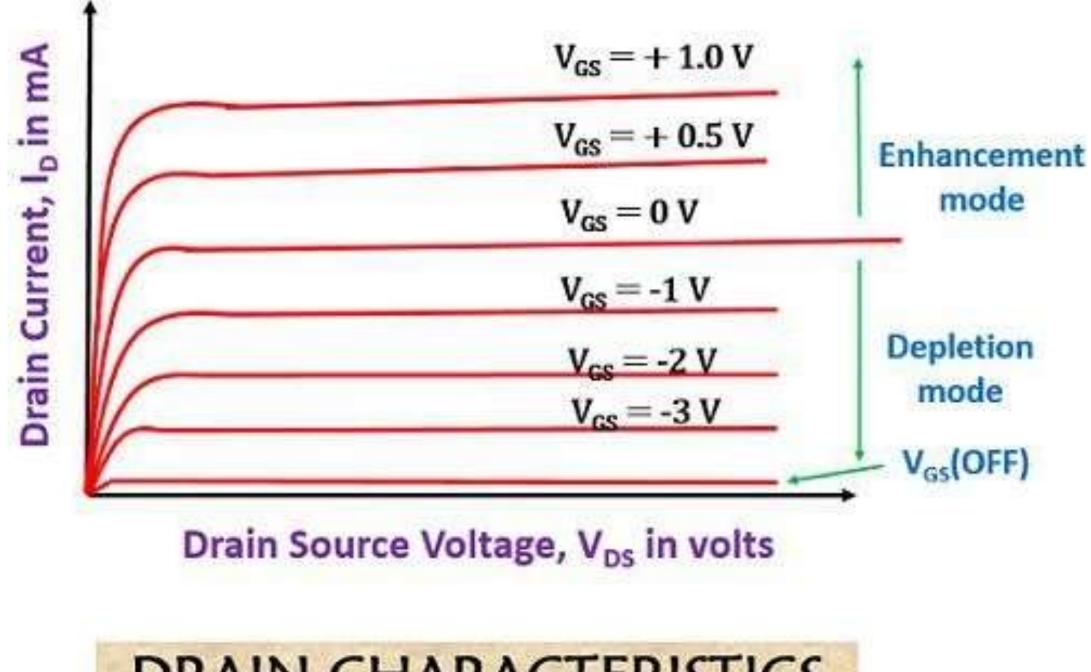
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a much negative gate voltage is applied.



Characteristic Curve of Depletion MOSFET



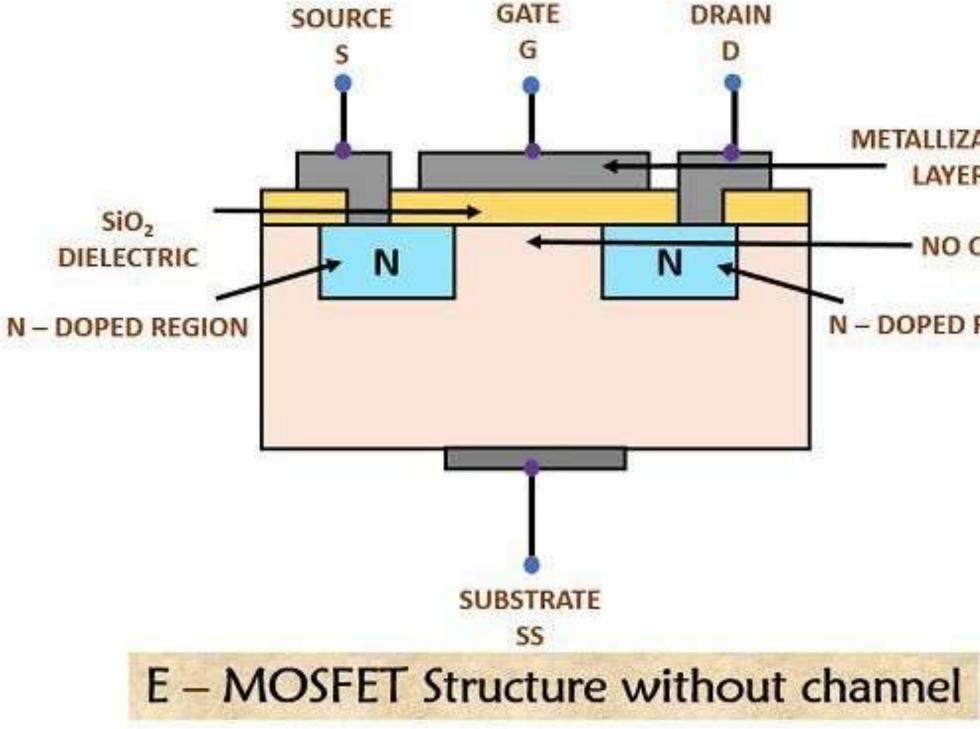
DRAIN CHARACTERISTICS







Construction of Enhancement type STS MOSFET



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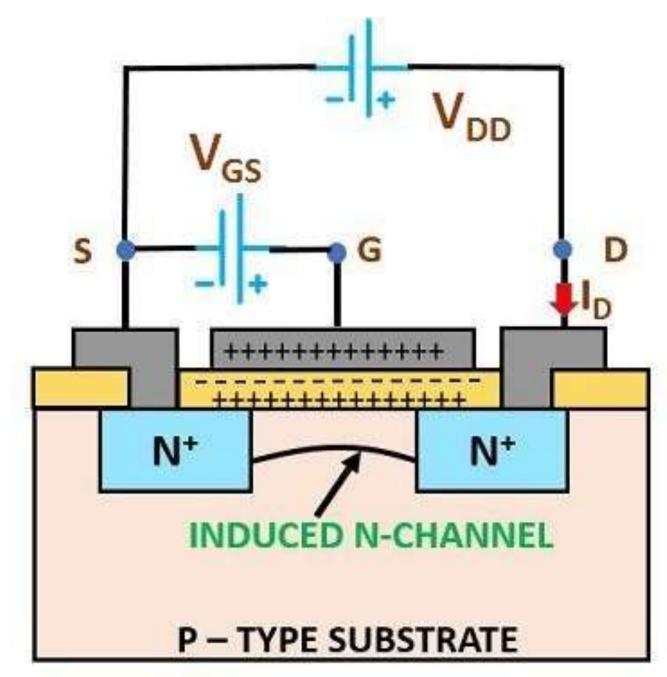
METALLIZATION LAYER

NO CHANNEL

N - DOPED REGION



Working of a Enhancement-type MOSFE



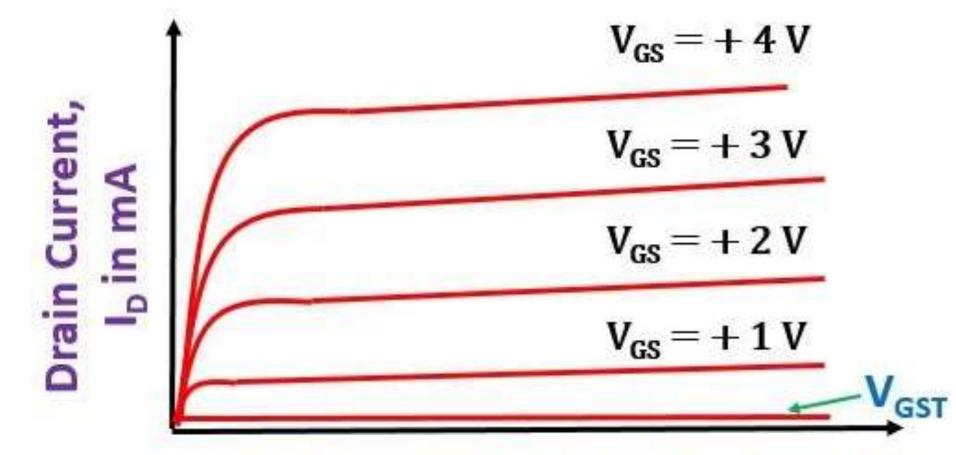
Operation of N-Channel E – MOSFET

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Characteristic Curve of Enhancement MOSFET



Drain Source Voltage, V_{DS} in volts

Drain Characteristics

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Comparison between BJT, FET and MOSFE

TERMS	BJT	FET	MOSFET
Device type	Current controlled	Voltage controlled	Voltage Controlled
Current flow	Bipolar	Unipolar	Unipolar
Terminals	Not interchangeable	Interchangeable	Interchangeable
Operational modes	No modes	Depletion mode only	Both Enhancement and Depletion modes
Input impedance	Low	High	Very high
Output resistance	Moderate	Moderate	Low
Operational speed	Low	Moderate	High
Noise	High	Low	Low
Thermal stability	Low	Better	High
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SUMMARY

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keep learning.. **Thank u**

SEE YOU IN NEXT CLASS



